

KAA-3528RGBS-K11-C8-CC

3.5 x 2.8 mm Surface Mount LED Lamp



DESCRIPTIONS

- The Hyper Red device is based on light emitting diode chip made from AlGaInP
- The Green source color devices are made with InGaN Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- Suitable for all SMD assembly and solder process
- · Available on tape and reel
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · RoHS compliant

APPLICATIONS

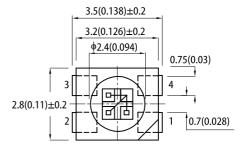
- Backlight
- Status indicator
- Home and smart appliances
- · Wearable and portable devices
- Healthcare applications

ATTENTION

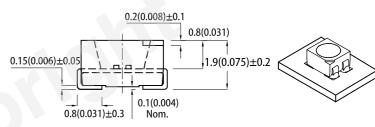
Observe precautions for handling electrostatic discharge sensitive devices



PACKAGE DIMENSIONS

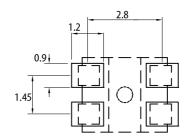






RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



1. All dimensions are in millimeters (inches)

Tolerance is ±0.25(0.01") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to

change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]	
			Min.	Тур.	201/2	
KAA-3528RGBS-K11-C8-CC	Hyper Red (AlGaInP)		400	500		
	Green (InGaN)	Water Clear	1000	1600	120°	
	Blue (InGaN)		200	330		

Notes

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
 3. Luminous intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Demonster	Current of	Envitting Online	Value		1114	
Parameter	Symbol	Emitting Color	Тур.	Max.	Unit	
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Hyper Red Green Blue	640 520 465	-	nm	
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	Hyper Red Green Blue	625 525 470	-	nm	
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	n at 50% Φ REL MAX Δλ Hyper Red Green Blue		20 35 22	-	nm	
Capacitance	С	Hyper Red Green Blue	27 100 100	-	pF	
Forward Voltage I _F = 20mA	V _F ^[2]	Hyper Red Green Blue	2.2 3.2 3.3	2.8 4.0 4.0	V	
Reverse Current (V _R = 5V)	I _R	Hyper Red Green Blue	-	10 50 50	uA	

Notes:
 The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Demonster	Symbol	Value			
Parameter		Hyper Red	Green	Blue	Unit
Power Dissipation	PD	140	120	120	mW
Reverse Voltage	V _R	5	5	5	V
Junction Temperature	Tj	115	115	115	°C
Operating Temperature	T _{op}	-40 to +85			°C
Storage Temperature	T _{stg}	-40 to +85			°C
DC Forward Current	l _F	50	30	30	mA
Peak Forward Current	۱ _{FM} ^[1]	150	100	100	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	250	V

Notes: 1. 1/10Duty Cycle , 0.1ms Pulse Width . 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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30°

0.5

Luminous Intensity vs.

Ambient Temperature

45°

60

75°

90

1.0

0

0.0

2.5

2.0

1.0

0.5

0.0

-40

Luminous intensity normalised

ů 1.5

at $T_a = 25$

SPATIAL DISTRIBUTION

30

0.5

T_a = 25 °C

-60

-75

-90°

1.0

TECHNICAL DATA RELATIVE INTENSITY vs. WAVELENGTH Red 100% T_a = 25 °C Relative Intensity (a. u.) 80% 60% 40% 20% 0% 600 650 800 350 400 450 500 550 700 750 Wavelength (nm) **HYPER RED** Forward Current vs. Luminous Intensity vs. Forward Current Derating Curve Forward Voltage Forward Current 2.5 50 60 (mA) T_a = 25 °C Luminous intensity normalised T_a = 25 °C 50 40 2.0 current Forward current (mA) 40 at 50 mA 0.1 20 mA 30 forward 30 20 20 Permissible 10 0.5 10 0 0.0 0 1.9 2.1 2.3 2.5 0 20 30 40 50 -20 1.5 1.7 10 -40 Forward voltage (V) Forward current (mA) Ambient temperature (°C) GREEN Forward Current vs Luminous Intensity vs. Forward Voltage Forward Current 2.5 50 50 (WA) Luminous intensity normalised at T_a = 25 °C T_a = 25 °C 40 2.0 Forward current (mA)

1.5 20 mA 1.0

0.5

0.0

0 10 20 30 40

Forward Current Derating Curve Luminous intensity normalised at $T_a = 25 \ ^\circ C$ 40 Permissible forward current 30 20 10 0 -20 0 20 40 60 50 -40 80 100 Ambient temperature (°C)

0

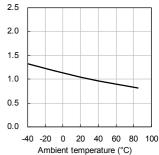
20 40 60

80 100

Luminous Intensity vs. Ambient Temperature

-20 0 20 40 60 80 100

Ambient temperature (°C)



Forward Current vs. Forward Voltage

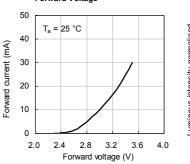
30

20

10

0

2.0 2.5 3.0 3.5



Forward voltage (V)

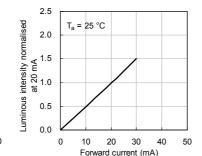
4.0

4.5

Luminous Intensity vs. Forward Current

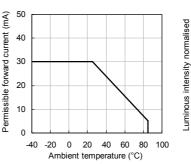
Forward current (mA)

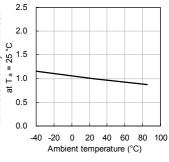
BLUE



Forward Current Derating Curve

Luminous Intensity vs. Ambient Temperature



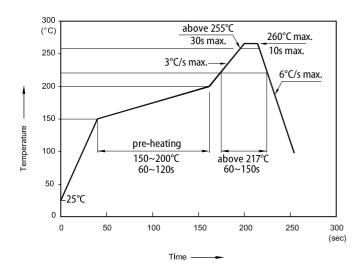


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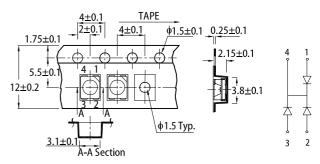
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TECHNICAL DATA

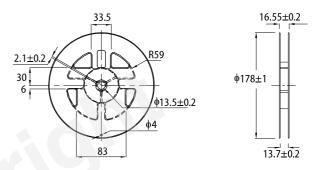
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



Notes

Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might

cause damage to the product

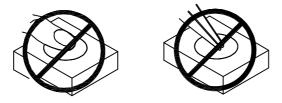
HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



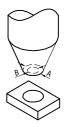
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



- 4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.
- 5. As silicone encapsulation is permeable to gases, some corrosive substances such as H₂S might corrode silver plating of lead frame. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

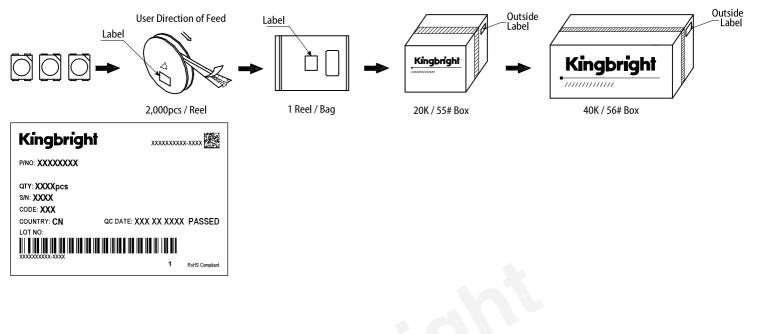
3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.





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PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications. 2.
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